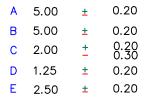
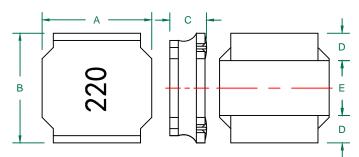
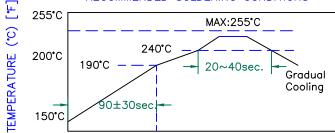
TYS5020220M-10

PHYSICAL DIMENSIONS:

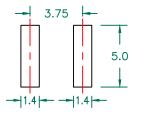


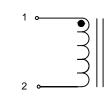


RECOMMENDED SOLDERING CONDITIONS



LAND PATTERNS FOR REFLOW SOLDERING

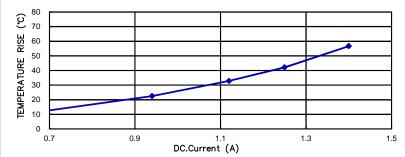




ELECTRICAL SPECIFICATION

	Min	Nom	Max
INDUCTANCE (uH) L @ 100 KHz/1V ± 20%	17.6	22.0	26.4
DCR (Ω)			0.294

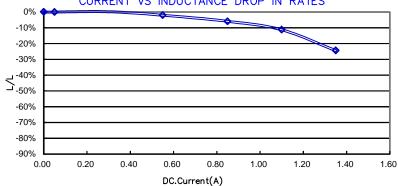
CHARACTERISTICS OF TEMPERATURE RISE





Saturation Current(A)	1.15
SRF (MHz)	14
Temperature Rise Current (A)	1.10
L Garrent (71)	

CURRENT VS INDUCTANCE DROP IN RATES



NOTES:

- 1.OPERATION TEMPERATURE RANGE: -40°C~+125°C (INCLUDING SELF-HEATING).
- 2.STORAGE TEMPERATURE RANGE (PACKAGING CONDITIONS): -10°C TO +40°C AND RH 70% (MAX.)
- 3.UNLESS OTHERWISE SPECIFIED, THE STANDARD ATMOSPHERIC CONDITIONS FOR MEASUREMENT/TEST AS:

 A. AMBIENT TEMPERATURE: 201150.
- B. RELATIVE HUMIDITY: 65%±20%.
- 4.SATURATION CURRENT IS THE DC CURRENT AT WHICH THE INDUCTANCE DROPS OFF APPROXIMATELY 30% FROM ITS VALUE WITHOUT CURRENT.(AMBIENT TEMPERATURE 25±5°C)

5.TEMPERATURE RISE CURRENT (IRMS):

DC CURRENT THAT CAUSES THE TEMPERATURE RISE (△T ≤40°C) FROM 25°C AMBIENT.

	DIMENSIONS ARE IN mm .			This print is the property of Lairr Tech. and is loaned in confidence subject to return upon request a with the understanding that no copies shall be made without the written consent of Laird Tech. All rights to design or invention are reserved.	e ind	Laird			
				PROJECT/PART NUMBER:	REV	PART T		DRAWN BY:	
С	CHANGE DIMENSIONS: C	07/28/16		TYS5020220M-10	(WER ICTOR	QIU	
В	CHANGE LOGO	12/20/12			CALE:	NTS	SHEET:		
Α	ORIGINAL DRAFT	06/06/12	QIU	CAD #	OOL #	1413			
REV	DESCRIPTION	DATE	INT					1 of 1	